

# HSP

**NOTES:**

Current Rating: 1.0AMP  
 Withstand Voltage: 500V AC/DC  
 Contact Resistance: 20mΩ Max  
 Insulation Resistance: 1000MΩMin  
 Operation Temperature: -40°C to +105°C

Contact Material: Phosphor Bronze  
 Contact plating: Au or Sn over Ni  
 Insulator Material: PA6T+30%G, F UL94V-0

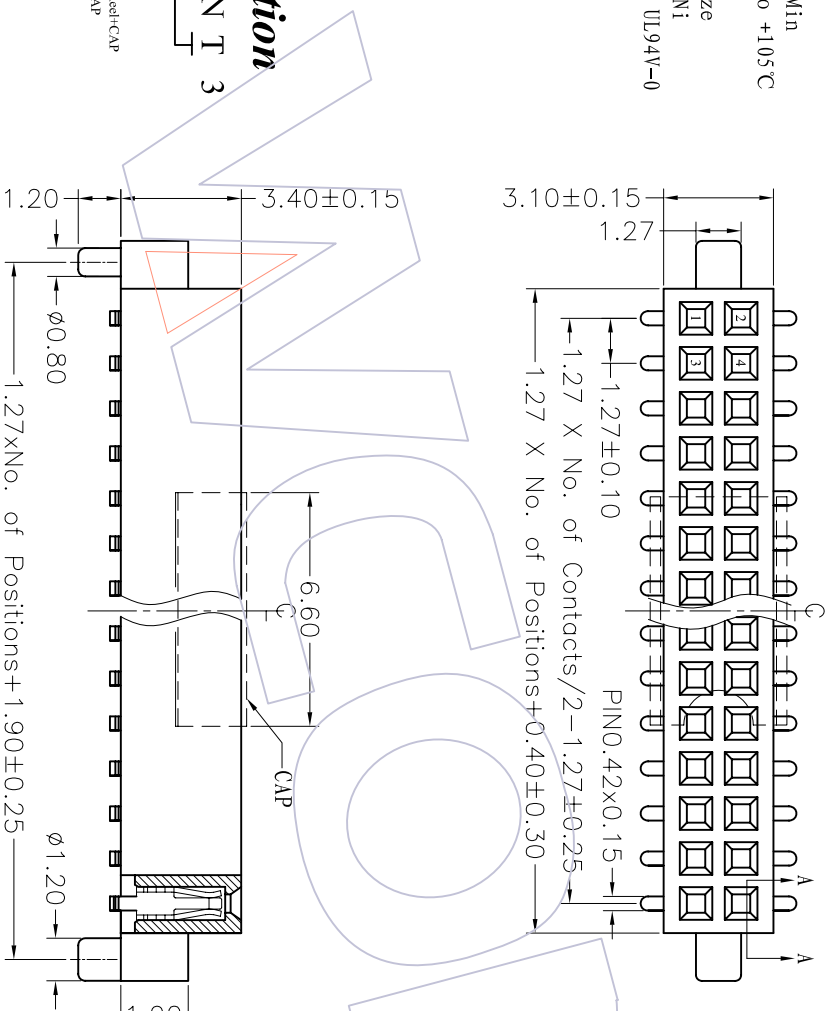
## Ordering Information

2334 - 2 XX M XX CUNT 3

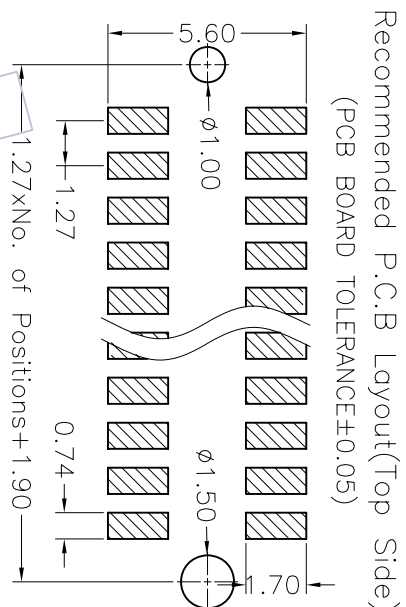
No. of Pins per ROW: 02-50Pin

Contact Plating: Au or Sn over Ni  
 GO=Gold Flash  
 GI=3μ'Gold  
 G2=5μ'Gold  
 G3=10μ'Gold  
 G4=15μ'Gold  
 G5=30μ'Gold  
 S0=Gold Flash/Tin  
 S1=3μ'Gold/Tin  
 S2=5μ'Gold/Tin  
 S3=10μ'Gold/Tin  
 S4=15μ'Gold/Tin  
 S5=30μ'Gold/Tin  
 SN=Tin

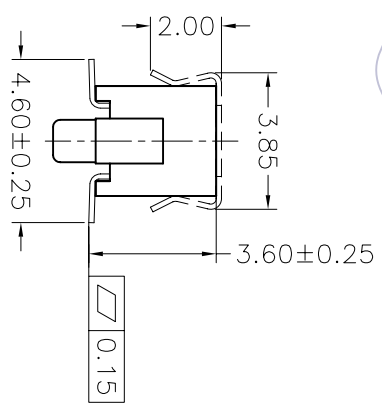
Packing:  
 T=Tube  
 R=Tube&Reel+CAP  
 P=Tube+CAP



SECTION A-A



Recommended P.C.B Layout(Top Side)  
 (PCB BOARD TOLERANCE±0.05)



REV	DATE	MODIFICATION DESCRIPTION	CHANGE	APPROVE	OPERATION	DRAW	SCALE	PART NO.	TITLE:
A0	08/02/16	NEW			XXX ±0.25	DESIGN	3:1 mm	2334-2XXMXXCUNT3	1.27mm DUAL FEMALE SMT H=3.40 WITH DIFFERENT POST AND METAL CAP
REV	DATE	MODIFICATION DESCRIPTION	CHANGE	APPROVE	Angle DIM	CHECK	UNIT	SIZE	SHEET
1					± 3'	APPROVE	A4	1/1	Customer NO.

**WCON** 维峰五金电子有限公司  
 WAVE HARDWARE ELECTRONICS CO.,LTD